

Electronic Patent Application Fee Transmittal**Application Number:**

10594057

Filing Date:

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Title of Invention:

Heat-Sealable Layered Polypropylene Resin Film and Package

First Named Inventor/Applicant Name:

Kenji Kawai

Filer:

Bradley J. Meier/Natherine Ordanza

Attorney Docket Number:

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U.S. National Stage under 35 USC 371 Filing Fees**Description****Fee Code****Quantity****Amount****Sub-Total in
USD(\$)****Basic Filing:****Pages:****Claims:****Miscellaneous-Filing:****Petition:****Patent-Appeals-and-Interference:****Post-Allowance-and-Post-Issuance:****Extension-of-Time:**

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
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| Miscellaneous: | | | | |
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